

DC-IM415AF-1400V1

TOP VIEW

SIDE VIEW

BOTTOM VIEW

Technical drawing of a composite material board, showing three cross-sectional views (A-A, B-B, and C-C) and their dimensions.

View A-A (Top): Shows the top surface with a central circular feature. Dimensions include a central hole diameter of $\phi 12$, an outer diameter of 20 ± 0.1 , and a thickness of 23.2 ± 0.2 . The central feature has a diameter of 14 and a height of 12.22 ± 0.2 . The board has a total width of 82.55 ± 0.2 and a thickness of 22 . The central feature is labeled "0.3 铜片补强接地" (0.3 mm copper plate reinforcement grounding).

View B-B (Middle): Shows the side profile of the board. Dimensions include a total width of 82.55 ± 0.2 , a central hole diameter of $\phi 12$, and a thickness of 23.2 ± 0.2 . The board is labeled "0.12 \pm 0.03 PC胶电绝缘" (0.12 \pm 0.03 PC resin electrical insulation).

View C-C (Bottom): Shows the bottom surface with a central circular feature. Dimensions include a central hole diameter of $\phi 1.8$, an outer diameter of 18.5 , and a thickness of 15.5 . The board is labeled "0.3 \pm 0.03 PCPI补强" (0.3 \pm 0.03 PCPI reinforcement).

NO.	CHG. SYMBO.
1	K.
2	AP-VIOL. 8V
3	PDVIOL. 2V
4	PDVIOL. 8V
5	K.
6	DEAD
7	AVIOL. 8V
8	AEAD
9	SA
10	SL.
11	RESET
12	FIN
13	DED
14	WJK
15	GO
16	WR3
17	WR3
18	GO
19	WR2
20	WR2
21	GO
22	WR1
23	WR1
24	DED
25	WR
26	WEN
27	DED
28	WR0
29	WR0
30	DED

E		光学规格		电子规格		其他规格		深圳市德创影像科技有限公司 项目名称: DC-IM415AF-1400V1							
镜头 (LENS)		56+11R		镜头类型 (Lens Size)		1/2.8"				泡棉尺寸					
焦距 (FFL)		12.5mm		感光芯片 (Chip Type)		IMX415				背胶规格					
光圈 (F-No)		3.6		像素 (Array Size)		3864*2228				驱动IC					
视场角 (View Angle)		35.7°		模拟电路电压 (AVDD)		2.9V				连接器					
畸变 (Distortion)		<0.5%		接口电路电压 (IOVDD)		1.8V				数字电路电压 (DVDD)					
1		2		3		4		5		6		7		8	
												.XXX ±0.005		角度 ±0.5° 圆角 R0.5mm	
												.XX ±0.005			
												.X ±0.005			
														绘图:	